



# tesa HAF® 8410 HS



## Product Information

60µm/2.4 mils amber reactive HAF mounting tape

## Product Description

tesa HAF® 8410 is a heat activated double-sided amber adhesive film based on reactive phenolic resin and nitrile rubber.

Special Features:

- Reliable chip module bonding
- Suitable for PVC, ABS, PET, and PC cards
- Good workability on all common implanting lines
- Outstanding ageing resistance
- Lifelong flexibility due to high rubber content

## Application Fields

tesa HAF® 8410 is especially designed for the embedding of chip-modules into smart cards. It is also suitable for bonding of all thermal resistant materials such as metal, glass, plastic, wood and textiles e.g. friction liners for clutches).

## Technical Information (average values)

The values in this section should be considered representative or typical only and should not be used for specification purposes.

## Product Construction

- |                    |                                    |                   |                   |
|--------------------|------------------------------------|-------------------|-------------------|
| • Backing material | none                               | • Total thickness | 60 µm             |
| • Type of adhesive | nitrile rubber /<br>phenolic resin | • Color           | 2.4 mils<br>amber |
| • Type of liner    | glassine                           |                   |                   |

## Properties/Performance Values

- |                                    |                      |
|------------------------------------|----------------------|
| • Bonding strength (dynamic shear) | 12 N/mm <sup>2</sup> |
|------------------------------------|----------------------|

## Additional Information

Technical recommendations for Smart Card applications:

tesa HAF® 8410 is not self adhesive. It is activated by heat and pressure over a certain interval. The following values are recommendations for machine parameters to start with. Please note that optimum parameters strongly depend on the type of machine, particular materials for card bodies and chip modules as well as customer requirements.

### 1. Pre-lamination:

During pre-lamination, the adhesive tape is laminated onto the module belt. The pre-lamination step does not affect the shelf life time of the adhesive tape. Pre-laminated belts can be stored over the same period of time as the adhesive tape.

For latest information on this product please visit <http://l.tesa.com/?ip=08410>



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Machine setting:

- Temperature 120 – 140 °C
- Pressure 2 – 3 bar
- Time 2.5 m/min

2. Module embedding:

During module embedding, the pre-laminated modules are cut from the module belt, positioned into the card cavity and permanently bonded to the card body by heat and pressure. Depending on the type of implanting line, single-step or multiple-step process are possible. Today, most implanting machines have multiple heat press steps.

Single-step process - machine setting:

- Temperature<sup>1</sup> 180 – 200 °C
- Pressure 65 – 75 N/module
- Time 1.5 s

Multiple-step process - machine setting:

- Temperature<sup>1</sup> 180 – 200 °C
- Pressure 65 – 75 N/module
- Time 2 x 0.7 s / 3 x 0.5 s

<sup>1</sup> Temperature measured inside the heating stamp. Different temperature settings recommended for different card materials:

PVC and ABS: 180 – 190 °C

PET and PC: 190 – 200 °C

Bonding strength values were obtained under standard laboratory conditions. Value is specification limit checked for each production batch (material: etched aluminum test specimen / bonding conditions: Temp. = 120 °C; pressure = 10 bar; time = 8 min).

To reach maximum bonding strength, surfaces should be clean and dry. Storage condition according to tesa HAF<sup>®</sup> shelf life concept.



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Product Information

## Disclaimer

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